

SPECIFICATIONS

Insulation Resistance:	500MΩ min. at 500V DC
Withstanding Voltage:	250V ACrms for 1 minute
Contact Resistance:	100mΩ max. at 10mA / 20mV max.
Current Rating:	0.5A
Voltage Rating:	5.0Vrms
Operating Temp. Range:	-55°C to +85°C
Mating Cycles:	5,000 insertions

MATERIALS AND FINISH

Insulator:	LCP, glass filled (UL94V-0)
Contact Plating:	Mating Face - Gold over Nickel Solder Tails - Gold over Nickel

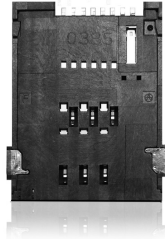
FEATURES

- Conforms to GSM11.11 standard for the European mobile phone system
- Smooth extraction function by Push / Push mechanism
- With and without switch
- For assembly on the bottom of the PC-Board
- Tape and Reel Packaging (800 pcs./reel)

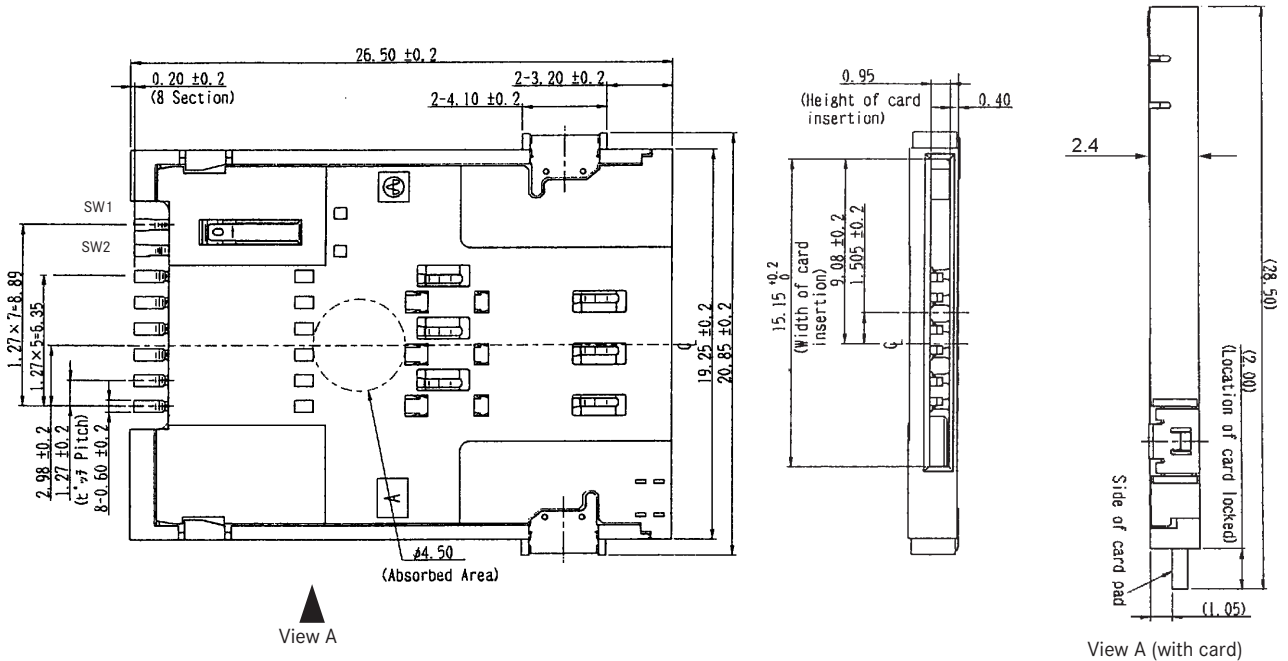
PART NUMBER

FMS006Z - 210 * - 0

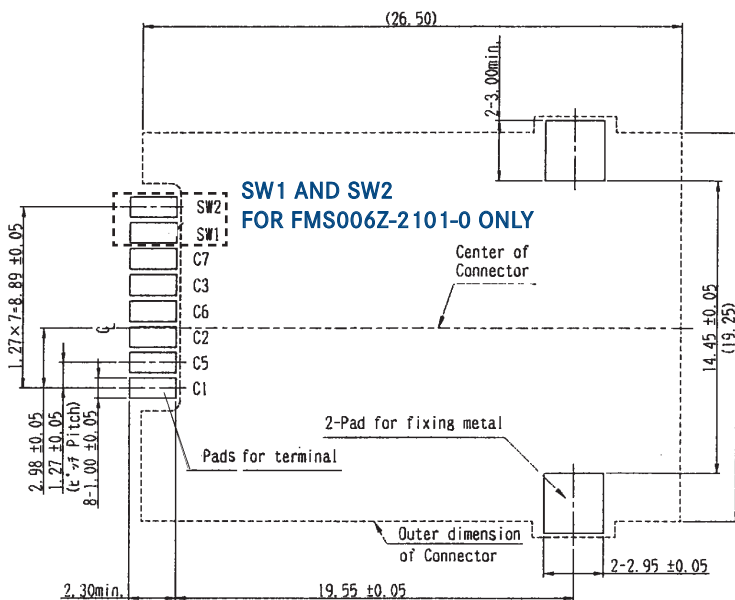
Series No.	
Design No.	
0 = Without Switch	1 = With Switch



OUTLINE CONNECTOR DIMENSIONS



RECOMMENDED PCB LAYOUT (MOUNTING SIDE)



CARD INSERTION

